

# MURB1660CT, NRVUB1660CTT4G

## Switch Mode Power Rectifier

### D<sup>2</sup>PAK Power Surface Mount Package

These state-of-the-art devices are designed for use in switching power supplies, inverters, and as free wheeling diodes.

#### Features

- Package Designed for Power Surface Mount Applications
- Ultrafast 60 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Epoxy Meets UL 94 V-0 @ 0.125 in
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 V
- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured – Not Sheared!
- Similar in Size to Industrial Standard TO-220 Package
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### Mechanical Characteristics:

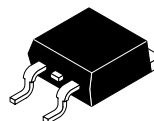
- Case: Epoxy, Molded, Epoxy Meets UL 94 V-0
- Weight: 1.7 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL1 Requirements
- ESD Ratings:
  - ♦ Machine Model, C > 400 V
  - ♦ Human Body Model, 3B > 8000 V



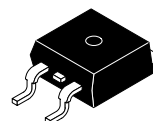
ON Semiconductor®

<http://onsemi.com>

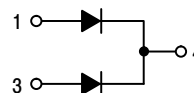
### ULTRAFAST RECTIFIER 16 AMPERES, 600 VOLTS



D<sup>2</sup>PAK  
CASE 418B  
STYLE 3



D<sup>2</sup>PAK  
CASE 418AJ  
STYLE 3



#### MARKING DIAGRAM



A = Assembly Location  
Y = Year  
WW = Work Week  
U1660 = Specific Device Code  
G = Pb-Free Package  
AKA = Diode Polarity

#### ORDERING INFORMATION

| Device         | Package                    | Shipping†         |
|----------------|----------------------------|-------------------|
| MURB1660CTG    | D <sup>2</sup> PAK (418AJ) | 50 Units/Rail     |
| MURB1660CTT4G  | D <sup>2</sup> PAK (418AJ) | 800 / Tape & Reel |
| NRVUB1660CTT4G | D <sup>2</sup> PAK (418B)  | 800 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MURB1660CT, NRVUB1660CTT4G

## MAXIMUM RATINGS (Per Leg)

| Rating                                                                                                      | Symbol                          | Value       | Unit             |
|-------------------------------------------------------------------------------------------------------------|---------------------------------|-------------|------------------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage                      | $V_{RRM}$<br>$V_{RWM}$<br>$V_R$ | 600         | V                |
| Average Rectified Forward Current<br>(Rated $V_R$ , $T_C = 150^\circ\text{C}$ ) Total Device                | $I_{F(AV)}$                     | 8.0<br>16   | A                |
| Peak Repetitive Forward Current<br>(Rated $V_R$ , Square Wave, 20 kHz, $T_C = 150^\circ\text{C}$ )          | $I_{FM}$                        | 16          | A                |
| Non-Repetitive Peak Surge Current<br>(Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | $I_{FSM}$                       | 100         | A                |
| Operating Junction and Storage Temperature Range                                                            | $T_J, T_{stg}$                  | -65 to +175 | $^\circ\text{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## THERMAL CHARACTERISTICS (Per Leg)

| Rating                                                           | Symbol          | Value | Unit               |
|------------------------------------------------------------------|-----------------|-------|--------------------|
| Maximum Thermal Resistance, Junction-to-Case                     | $R_{\theta JC}$ | 2.0   | $^\circ\text{C/W}$ |
| Maximum Thermal Resistance, Junction-to-Ambient (Note 1)         | $R_{\theta JA}$ | 50    | $^\circ\text{C/W}$ |
| Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds | $T_L$           | 260   | $^\circ\text{C}$   |

1. See Chapter 7 for mounting conditions.

## ELECTRICAL CHARACTERISTICS (Per Leg)

| Characteristic                                                                                                                                     | Symbol   | Max          | Unit          |
|----------------------------------------------------------------------------------------------------------------------------------------------------|----------|--------------|---------------|
| Maximum Instantaneous Forward Voltage (Note 2)<br>( $I_F = 8.0$ Amp, $T_C = 150^\circ\text{C}$ )<br>( $I_F = 8.0$ Amp, $T_C = 25^\circ\text{C}$ )  | $V_F$    | 1.20<br>1.50 | V             |
| Maximum Instantaneous Reverse Current (Note 2)<br>(Rated dc Voltage, $T_C = 150^\circ\text{C}$ )<br>(Rated dc Voltage, $T_C = 25^\circ\text{C}$ )  | $I_R$    | 500<br>10    | $\mu\text{A}$ |
| Maximum Reverse Recovery Time<br>( $I_F = 1.0$ Amp, $di/dt = 50$ Amp/ $\mu\text{s}$ )<br>( $I_F = 0.5$ Amp, $I_R = 1.0$ Amp, $I_{REC} = 0.25$ Amp) | $t_{rr}$ | 60<br>50     | ns            |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

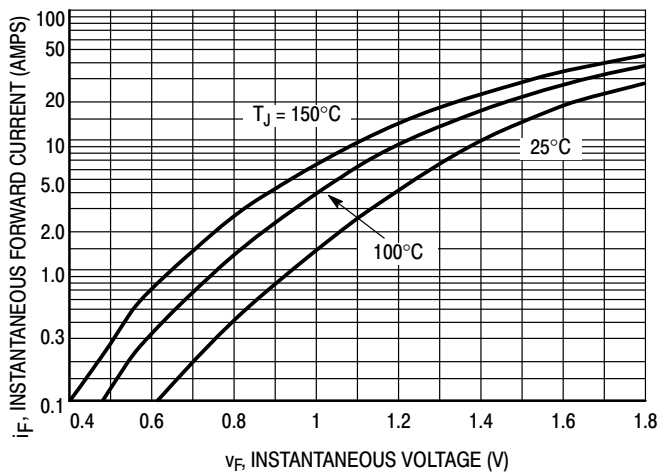


Figure 1. Typical Forward Voltage, Per Leg

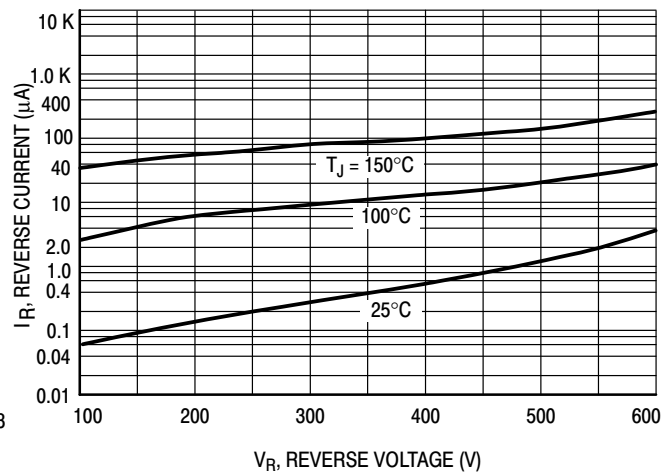


Figure 2. Typical Reverse Current, Per Leg

# MURB1660CT, NRVUB1660CTT4G

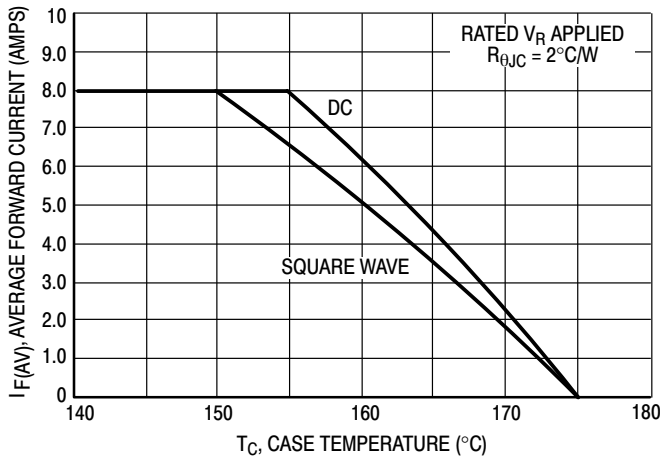


Figure 3. Current Derating, Case, Per Leg

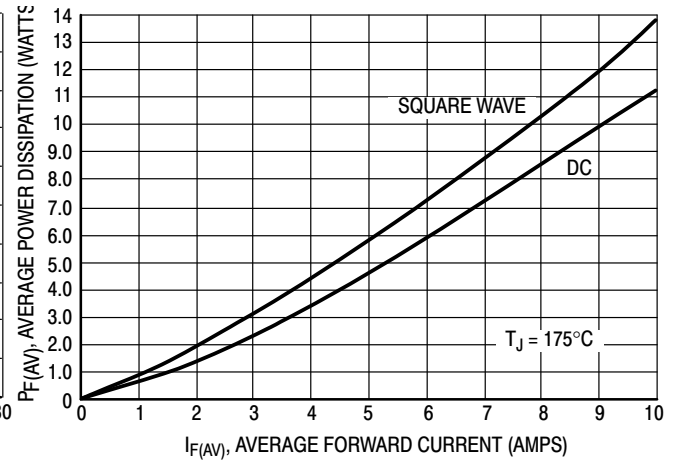


Figure 4. Power Dissipation, Per Leg

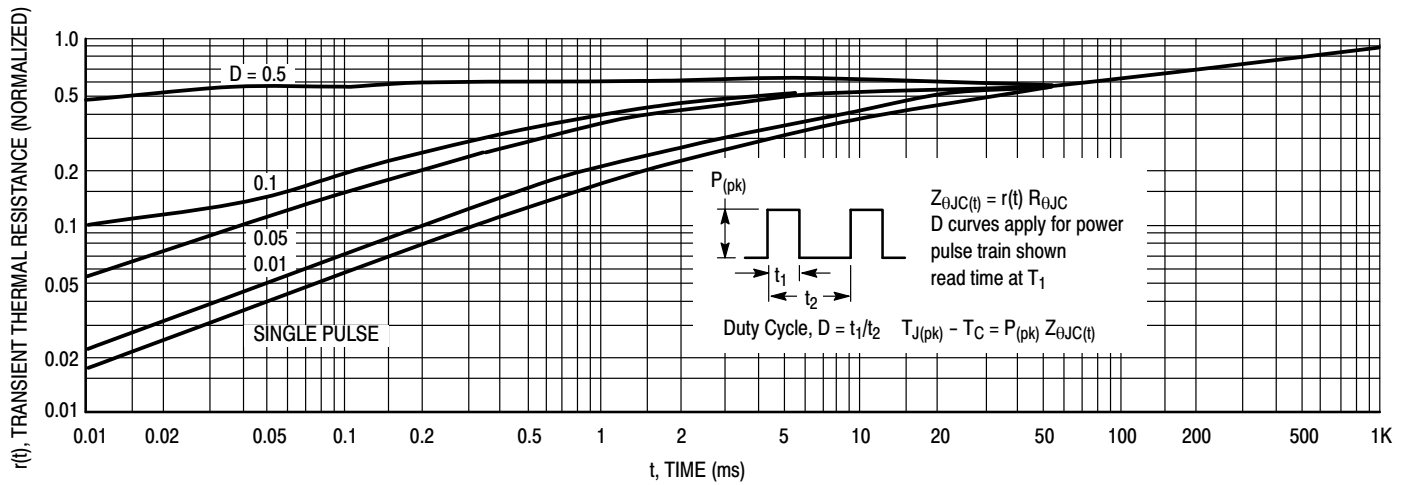


Figure 5. Thermal Response

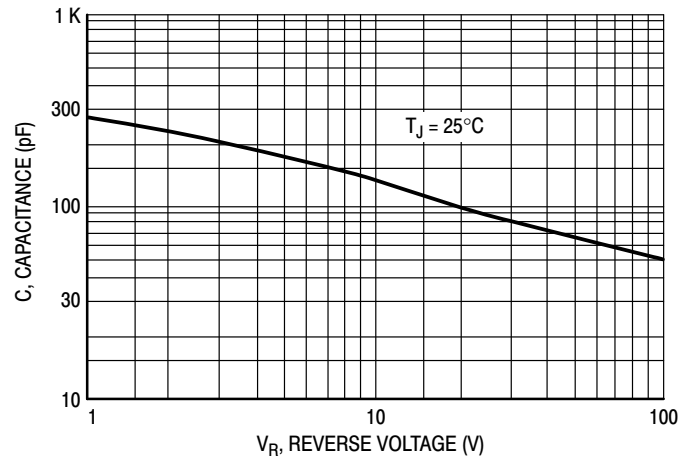
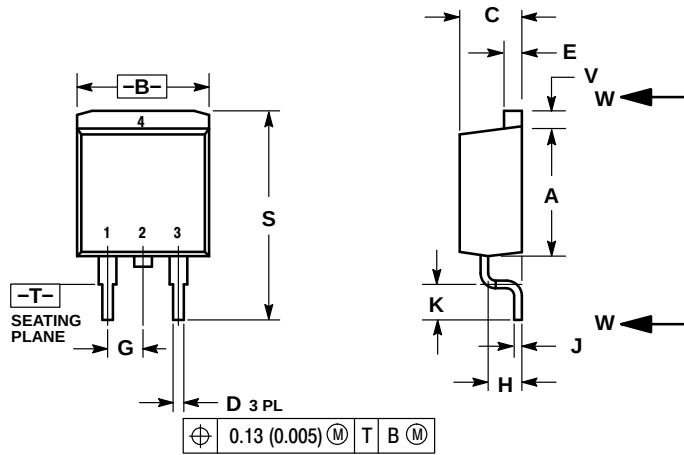


Figure 6. Typical Capacitance, Per Leg

# MURB1660CT, NRVUB1660CTT4G

## PACKAGE DIMENSIONS

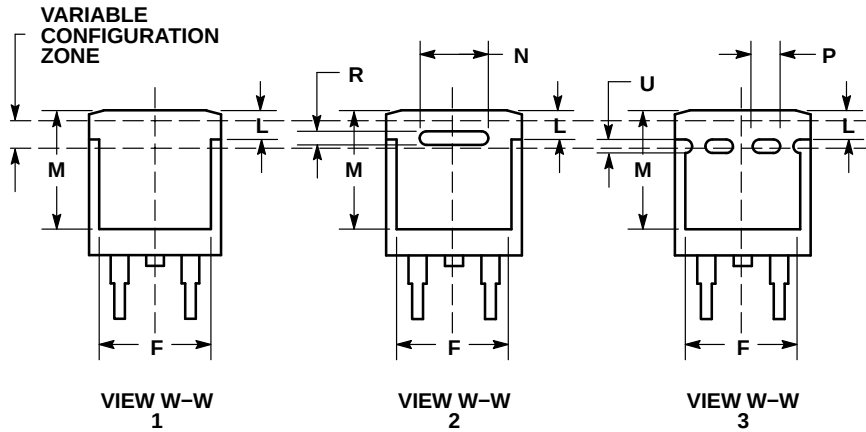
D<sup>2</sup>PAK 3  
CASE 418B-04  
ISSUE K



### NOTES:

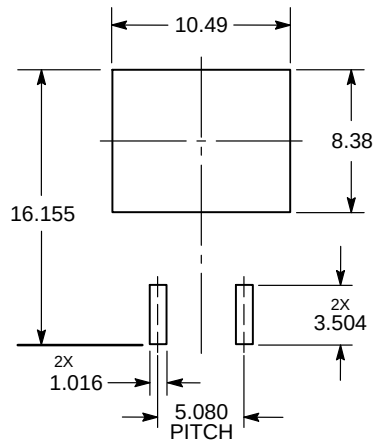
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.340     | 0.380 | 8.64        | 9.65  |
| B   | 0.380     | 0.405 | 9.65        | 10.29 |
| C   | 0.160     | 0.190 | 4.06        | 4.83  |
| D   | 0.020     | 0.035 | 0.51        | 0.89  |
| E   | 0.045     | 0.055 | 1.14        | 1.40  |
| F   | 0.310     | 0.350 | 7.87        | 8.89  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| H   | 0.080     | 0.110 | 2.03        | 2.79  |
| J   | 0.018     | 0.025 | 0.46        | 0.64  |
| K   | 0.090     | 0.110 | 2.29        | 2.79  |
| L   | 0.052     | 0.072 | 1.32        | 1.83  |
| M   | 0.280     | 0.320 | 7.11        | 8.13  |
| N   | 0.197 REF |       | 5.00 REF    |       |
| P   | 0.079 REF |       | 2.00 REF    |       |
| R   | 0.039 REF |       | 0.99 REF    |       |
| S   | 0.575     | 0.625 | 14.60       | 15.88 |
| V   | 0.045     | 0.055 | 1.14        | 1.40  |



STYLE 3:  
PIN 1. ANODE  
2. CATHODE  
3. ANODE  
4. CATHODE

### SOLDERING FOOTPRINT\*



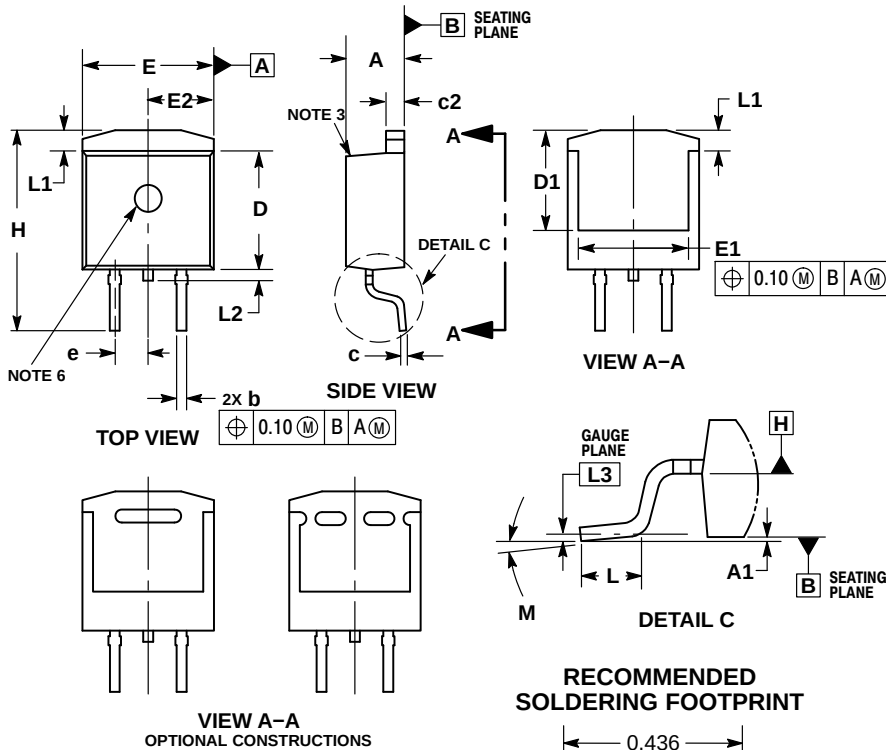
DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MURB1660CT, NRVUB1660CTT4G

## PACKAGE DIMENSIONS

### D<sup>2</sup>PAK-3 (TO-263, 3-LEAD) CASE 418AJ ISSUE B



#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: INCHES.
3. CHAMFER OPTIONAL
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.005 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
5. THERMAL PAD CONTOUR IS OPTIONAL WITHIN DIMENSIONS E, L1, D1 AND E1.
6. OPTIONAL MOLD FEATURE

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.160     | 0.190 | 4.06        | 4.83  |
| A1  | 0.000     | 0.010 | 0.00        | 0.25  |
| b   | 0.020     | 0.039 | 0.51        | 0.99  |
| c   | 0.012     | 0.029 | 0.30        | 0.74  |
| c2  | 0.045     | 0.065 | 1.14        | 1.65  |
| D   | 0.330     | 0.380 | 8.38        | 9.65  |
| D1  | 0.260     | ---   | 6.60        | ---   |
| E   | 0.380     | 0.420 | 9.65        | 10.67 |
| E1  | 0.245     | ---   | 6.22        | ---   |
| e   | 0.100 BSC |       | 2.54 BSC    |       |
| H   | 0.575     | 0.625 | 14.60       | 15.88 |
| L   | 0.070     | 0.110 | 1.78        | 2.79  |
| L1  | ---       | 0.066 | ---         | 1.68  |
| L2  | ---       | 0.070 | ---         | 1.78  |
| L3  | 0.010 BSC |       | 0.25 BSC    |       |
| M   | 0°        | 8°    | 0°          | 8°    |

#### STYLE 3:

- PIN 1. ANODE
- CATHODE
- ANODE
- CATHODE

ON Semiconductor and are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## PUBLICATION ORDERING INFORMATION

### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor  
P.O. Box 5163, Denver, Colorado 80217 USA  
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada  
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada  
Email: [orderlit@onsemi.com](mailto:orderlit@onsemi.com)

N. American Technical Support: 800-282-9855 Toll Free  
USA/Canada  
Europe, Middle East and Africa Technical Support:  
Phone: 421 33 790 2910  
Japan Customer Focus Center  
Phone: 81-3-5817-1050

ON Semiconductor Website: [www.onsemi.com](http://www.onsemi.com)

Order Literature: <http://www.onsemi.com/orderlit>

For additional information, please contact your local Sales Representative

MURB1660CT/D

## Данный компонент на территории Российской Федерации

**Вы можете приобрести в компании MosChip.**

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

moschip.ru\_6

moschip.ru\_9